

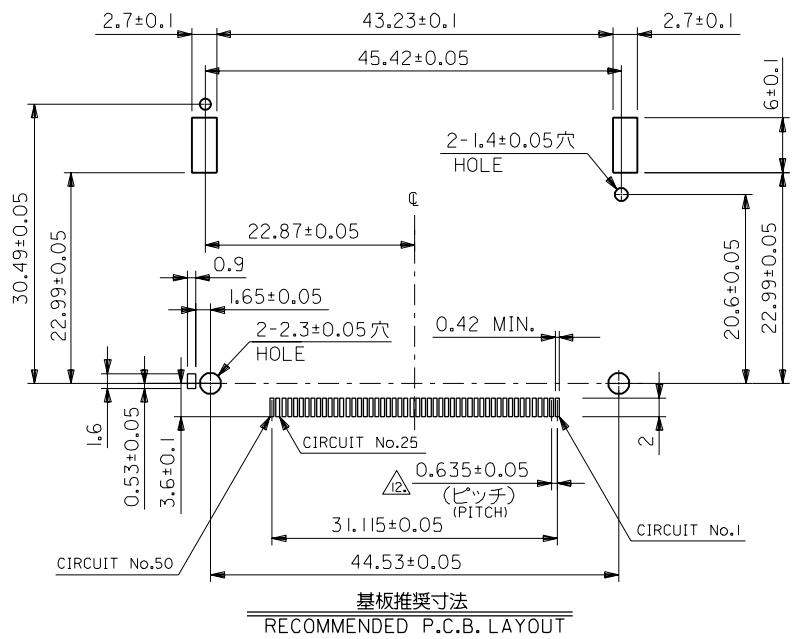
DO NOT SCALE DRAWING

EC NO. DRWN: CHK: APPR:		EC NO. DRWN: CHK: APPR:		EC NO. DRWN: CHK: APPR:		EC NO. DRWN: CHK: APPR:		EC NO. DRWN: CHK: APPR:		RELEASED EC NO. JD2000-0289 DRWN: HIRATA '99/09/27 CHK: MSASAO '99/09/27 APPR: HIKESUGI '99/09/27		MATERIAL 材料 SEE NOTES		GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差		SCALE 2-1		DESIGN UNITS <input checked="" type="checkbox"/> mm <input type="checkbox"/> INCH		DIMENSIONS: <input type="checkbox"/> mm <input type="checkbox"/> INCH <input checked="" type="checkbox"/> mm ONLY		SHT REV REVISE ON CAD ONLY			
10 UNDER 未満		10 OVER 以上		30 UNDER 未満		30 OVER 以上		ANGLE 角度		DRAWN BY & DATE Y. Hirata '99/09/27		CHECKED BY & DATE H. Sasaki '99/09/27		APPROVED BY & DATE H. Sasaki '99/09/27		TITLE: CF CARD CONN. 50P HEADER ASS'Y (NORMAL TYPE)		MOLEX INCORPORATED		MATERIAL NO. 55244-5021		DRAWING NO. SD-55244-008		SHEET NO. 1 OF 2	
WIRE RANGE 通孔線径範囲		FINISH 仕上り		INS. RANGE 被覆外径		CAD FILENAME SD-55244-008.S01		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.		SIZE B		55244-5021 MODEL No.		EN-02J(097) MXJ-54											

DWG. NO. SD-55244-008

注) NOTES

1. 材質 MATERIAL
ハウジング : ガラス入り耐熱樹脂 UL94V-0
HOUSING: LIQUID CRYSTAL POLYMER GLASS FILLED UL94V-0
ピン : リン青銅
PIN: PHOSPHOR BRONZE
ネール : リン青銅
NAIL: PHOSPHOR BRONZE
 2. メッキ仕様 PIN 接点部 金めっき
PLATING CONTACT AREA GOLD PLATING
半田付け部 半田めっき
SOLDER TAIL AREA TIN-LEAD PLATING
下地めっき ニッケルめっき
UNDERPLATING NICKEL PLATING
NAIL 接点部 金めっき
CONTACT AREA GOLD PLATING
半田付け部 半田めっき
SOLDER TAIL AREA TIN-LEAD PLATING
下地めっき ニッケルめっき
UNDERPLATING NICKEL PLATING
 3. 推奨基板厚 : t0.8 MIN.
RECOMMENDED P.C.B. THICKNESS: t0.8 MIN.
 4. 適合カード厚 : 3.3±0.1 (TYPE I) AND 5 MAX. (TYPE II)
RECOMMENDED CARD THICKNESS: 3.3±0.1 (TYPE I) AND 5 MAX. (TYPE II)
 5. 適合カード幅 : 42.8±0.1
RECOMMENDED CARD WIDTH: 42.8±0.1
 6. ハウジング色 : 黒
HOUSING COLOR: BLACK
- △12 寸法適用極 : 1,13,38,50
THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 1,13,38 AND 50.
- △13 寸法適用極 : 25,26
THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 25 AND 26.
- △14 ピンの倒れは、ピン根元を基準に全方向へ0.1 MAX.とする。
PIN TIP LEAN TOWARD ANY DIRECTION NOT TO EXCEED 0.1 WHEN MEASURED FROM PIN BASE.
- △15 ピン根元に適用する。
THIS DIMENSION TO BE MEASURED AT PIN BASE.
- △16 ソルダータール及びネールは、Z面を基準とし上へ0.05 下へ0.15の範囲にあり、且つソルダータールの平坦度は、0.12 MAX. とし、テール先端にて測定する。
SOLDERTAILS AND FITTING NAILS TO BE WITHIN 0.05 UPWARD AND 0.15 DOWNWARD FROM Z-DATUM PLACE, AND COPLANARITY OF SOLDERTAILS TO BE WITHIN 0.12.
MEASUREMENT POINT IS SOLDERTAILS TIP.



- △12 公差非累積
NON-CUMULATIVE
- △13 テールとネールを併せた平坦度は、0.12 MAX.とする。
TOTAL COPLANARITY OF SOLDER TAILS AND FITTING NAILS TO BE 0.12 MAX.
- △14 ボタンストロークが (6 mm) の時、カード飛び出し量は (3.25mm)。
WHEN BUTTON PUSH STROKE IS (6mm), CARD OUT BY (3.25mm).
15. 適合 SHEEL ASS'Y : 55246-001* , 58773-0010
APPLICABLE SHELL ASS'Y : 55246-001* , 58773-0010

DO NOT SCALE DRAWING

EC NO. DRWN: CHK: APPR:				SEE SHEET 1 OF 2				MATERIAL 材料 SEE NOTES		GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差		SCALE 2-1		DESIGN UNITS <input checked="" type="checkbox"/> mm <input type="checkbox"/> INCH		DIMENSIONS: <input type="checkbox"/> mm <input type="checkbox"/> INCH <input checked="" type="checkbox"/> mm ONLY		SHT REV			
EC NO. DRWN: CHK: APPR:				SEE SHEET 1 OF 2				FINISH 仕上げ SEE NOTES		10 UNDER 未満 ±0.2		DRAWN BY & DATE H. Wrota '99/09/27		THIRD ANGLE PROJECTION		TITLE: CF CARD CONN. 50P HEADER ASS'Y (NORMAL TYPE)		REVISE ON CAD ONLY			
EC NO. DRWN: CHK: APPR:				SEE SHEET 1 OF 2				WIRE RANGE 適用電線規格 —		10 OVER 以上 30 UNDER 未満 ±0.25		CHECKED BY & DATE H. Sato '99/09/27		MOLEX INCORPORATED		MATERIAL NO. 55244-5021		DRAWING NO. SD-55244-008			
EC NO. DRWN: CHK: APPR:				SEE SHEET 1 OF 2				INS. RANGE 被覆外径 —		30 OVER 以上 ±0.3		APPROVED BY & DATE [Signature] '99/09/27		CAD FILENAME SD-55244-008.S02		SHEET NO. 2		SIZE B			
REV										ANGLE 角度 ±3°		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.									